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Application Data Sheet 37 CFR 1.76		Attorney Docket Number	17314-018
		Application Number	
Title of Invention	PALLADIUM-PLATED LEAD FINISHING STRUCTURE FOR SEMICONDUCTOR PART AND METHOD OF PRODUCING SEMICONDUCTOR DEVICE		
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Secrecy Order 37 CFR 5.2

- ☐ Portions or all of the application associated with this Application Data Sheet may fall under a Secrecy Order pursuant to 37 CFR 5.2 (Paper filers only. Applications that fall under Secrecy Order may not be filed electronically.)

Applicant Information:

Applicant 1			
Applicant Authority <input checked="" type="radio"/> Inventor		<input type="radio"/> Legal Representative under 35 U.S.C. 117	
		<input type="radio"/> Party of Interest under 35 U.S.C. 118	
Prefix	Given Name	Middle Name	Family Name
	Kazumitsu		Seki
Residence Information (Select One) <input type="radio"/> US Residency <input checked="" type="radio"/> Non US Residency <input type="radio"/> Active US Military Service			
City	Nagano	Country Of Residence	JP
Citizenship under 37 CFR 1.41(b) i		JP	
Mailing Address of Applicant:			
Address 1	c/o Shinko Electric Industries, Co., Ltd.		
Address 2	80, Oshimadamachi, Nagano-shi		
City	Nagano	State/Province	
Postal Code	3812287	Country	JP
Applicant 2			
Applicant Authority <input checked="" type="radio"/> Inventor		<input type="radio"/> Legal Representative under 35 U.S.C. 117	
		<input type="radio"/> Party of Interest under 35 U.S.C. 118	
Prefix	Given Name	Middle Name	Family Name
	Takashi		Yoshie
Residence Information (Select One) <input type="radio"/> US Residency <input checked="" type="radio"/> Non US Residency <input type="radio"/> Active US Military Service			
City	Nagano	Country Of Residence	JP
Citizenship under 37 CFR 1.41(b) i		JP	
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City	Nagano	State/Province	
Postal Code	3812287	Country	JP
Applicant 3			
Applicant Authority <input checked="" type="radio"/> Inventor		<input type="radio"/> Legal Representative under 35 U.S.C. 117	
		<input type="radio"/> Party of Interest under 35 U.S.C. 118	
Prefix	Given Name	Middle Name	Family Name
	Munesaki		Kure
Residence Information (Select One) <input type="radio"/> US Residency <input checked="" type="radio"/> Non US Residency <input type="radio"/> Active US Military Service			
City	Nagano	Country Of Residence	JP

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All inventors Must Be Listed - Additional inventor information blocks may be generated within this form by selecting the Add button.			

Correspondence Information:

Enter either Customer Number or complete the Correspondence Information section below. For further information see 37 CFR 1.33(a).			
<input type="checkbox"/> An Address is being provided for the correspondence information of this application.			
Customer Number	54205		
Email Address	jcalvaruso@chadbourne.com	Add Email	Remove Email

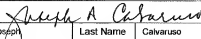
Application Information:

Title of the Invention	PALLADIUM-PLATED LEAD FINISHING STRUCTURE FOR SEMICONDUCTOR PART AND METHOD OF PRODUCING SEMICONDUCTOR DEVICE		
Attorney Docket Number	17314-018	Small Entity Status Claimed	<input type="checkbox"/>
Application Type	Nonprovisional		
Subject Matter	Utility		
Suggested Class (if any)		Sub Class (if any)	
Suggested Technology Center (if any)			
Total Number of Drawing Sheets (if any)	2	Suggested Figure for Publication (if any)	
Publication Information:			
<input checked="" type="checkbox"/> Request Early Publication (Fee required at time of Request 37 CFR 1.219)			
<input type="checkbox"/> Request Not to Publish. I hereby request that the attached application not be published under 35 U.S.C. 122(b) and certify that the invention disclosed in the attached application has not been and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.			

Representative Information:

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Signature			Date (YYYY-MM-DD)	2006-10-04	
First Name	Joseph	Last Name	Calvaruso	Registration Number	28287

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. **SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.**